505839701 12/27/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5886635

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LI GUO	01/03/2018
EKO ONGGOSANUSI	01/02/2018

RECEIVING PARTY DATA

Name:	ame: SAMSUNG ELECTRONICS CO., LTD	
Street Address: 129, SAMSUNG-RO, YEONGTONG-GU		
City: SUWON-SI, GYEONGGI-DO		
State/Country: KOREA, REPUBLIC OF		
Postal Code:	16677	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16728779	

CORRESPONDENCE DATA

Fax Number: (972)628-3616

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 972-628-3600

Email: patents@munckwilson.com
Correspondent Name: DOCKET CLERK - SAMS
Address Line 1: P.O. DRAWER 800889
Address Line 4: DALLAS, TEXAS 75380

ATTORNEY DOCKET NUMBER:	2017.01.014.SR1
NAME OF SUBMITTER:	JACOB L. LACOMBE
SIGNATURE:	/Jacob L. LaCombe/
DATE SIGNED:	12/27/2019

Total Attachments: 2

source=2017-01-014-SR1_ExecutedDeclarationAssignment#page1.tif source=2017-01-014-SR1_ExecutedDeclarationAssignment#page2.tif

PATENT 505839701 REEL: 051378 FRAME: 0586

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention	METHOD AND APPARATUS FOR UPLINK BEAM MANAGEMENT IN NEXT GENERATION WIRELESS SYSTEMS			
As the undersi	gned inventor, I hereby declare that:			
This combined assignment is o	declaration and ⊠The attached application, or directed to: □ United States application or PCT International application number filed on			
The above-ide	ntified application was made or authorized to be made by me.			
I believe that I	am the original inventor or an original joint inventor of a claimed invention in the application.			
I have reviewed and understand the contents of the application including the claims, for which this combined declaration and assignment is being submitted.				
I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.				
WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 129, Samsung-ro, Yeongtong-gu Suwon-si, Gyeonggi-do, Korea (hereinafter referred to as "ASSIGNEE"), desires to acquire the entire right, title and interest in said invention and to any patent that may be granted thereon in the United States and foreign countries;				
NOW, THEREFORE, for good and valuable consideration, the receipt whereof is hereby acknowledged, We, the below named inventors, hereby sell, assign and transfer to said ASSIGNEE, its successors and assigns, the entire right, title and interest in the above-identified application and the invention disclosed therein in all countries, including all divisional applications, continuation applications, and corresponding priority applications including those to which priority is claimed under the International Convention of Paris including under 35 U.S.C. 119, substitutions, and renewals thereof, and to all patents that may be granted thereon, and all reissues thereof.				
We hereby authorize and request the Patent Office Officials in the United States and all foreign countries to issue patents, when granted, to said ASSIGNEE, its successors and assigns. Further, We agree that said ASSIGNEE, its successors and assigns, may apply for patents for the invention in foreign countries without further authorization from us. Also, We agree to execute all papers and generally to do everything possible to aid said ASSIGNEE, its successors and assigns, in obtaining and enforcing patents for the invention in all countries.				
I hereby acknowledge that any willful false statement made in this combined declaration and assignment is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.				
LEGAL NAM	E OF FIRST INVENTOR (e.g., full first name, middle initial, last name)			
Inventor:LI				

1

2017.01.014.SR0 SAMS10-01271

LEGAL NAME OF SECOND INVENTOR (e.g., full first name, middle initial, last name)				
Inventor:	Eko Onggosanusi	_ Date:	01/02/2018	
Signature: _				
Signature	- argumantha haga da an			

2

2017.01.014.SR0 SAMS10-01271

RECORDED: 12/27/2019

PATENT REEL: 051378 FRAME: 0588